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Pre Arrdt  
SDavis  
6/12/02

Attorney Docket No.: P64C1-US  
Express Mail No.: EL 438390712US

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In the application of: Khandros et al.  
Application No.: Not known  
Filing Date: October 4, 2001  
For: ELECTRONIC COMPONENT  
OVERLAPPING DICE OF  
UNSINGULATED SEMICONDUCTOR  
WAFER

Examiner: Not Known  
Group Art Unit: Not Known

**PRELIMINARY AMENDMENT**

Box: Patent Application  
Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

Prior to examination of the above-identified patent application filed concurrently herewith, please amend the application as follows:

In the Title:

**Please replace the current title with the following title:**

--ELECTRONIC COMPONENT OVERLAPPING DICE OF UNSINGULATED SEMICONDUCTOR WAFER--

In the Specification:

**Please replace the paragraph on page 1, lines 8-22 with the following paragraph:**

This application is a continuation of application serial no. 09/114,589, filed July 13, 1998.

09/114,589-10494

B1